## **LINEA DT 15**



## METAL EDGING AND LEVER-ARCH FILE ASSEMBLING LINES



Automatic modular line to crease board flats & set one finger ring. (CORD-R + DT15)

## **Technical features**

## **Material:**

- coated board
- fiber board or similar
- finger eyelets standard range

Cardboard thickness: 1 mm up to 3,5 mm

**Capacity:** up to 25 cycles/min. (with 2 creases)

Electrical power req.: 3,5 Kw

Compressed air: 70 NL/min.

(pressure 7 bar)

**Overall dimensions:** 

L=3500 mm; W=1550 mm; H=1600mm;



